

Photocouplers Photorelay

TLP3543

1. Applications

- · Mechanical relay replacements
- · Security Systems
- · Measuring Instruments
- Factory Automation (FA)
- · Amusement Equipment

2. General

The TLP3543 photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 6-pin DIP package. The low ON-state resistance and the high permissible ON-state current of the the TLP3543 make it suitable for power line control applications.

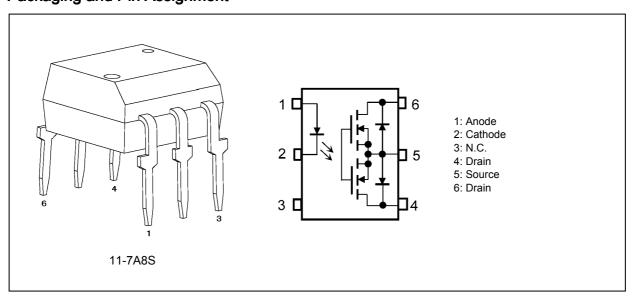
3. Features

- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 20 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 4 A (max) (A connection)
- (5) ON-state resistance: $50 \text{ m}\Omega$ (max) (A connection)
- (6) Isolation voltage: 2500 Vrms (min)
- (7) Safety standards

UL-approved: UL1577, File No.E67349

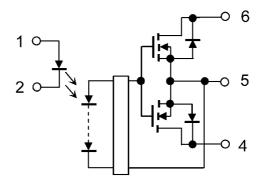
cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

4. Packaging and Pin Assignment





5. Internal Circuit



6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

| | Characteristics | | Symbol | Note | Rating | Unit |
|----------|--|---------------------------|-----------------------------------|----------|------------|-------|
| LED | Input forward current | | I _F | | 30 | mA |
| | Input forward current derating | $(T_a \ge 25 \text{ °C})$ | $\Delta I_F/\Delta T_a$ | | -0.3 | mA/°C |
| | Input forward current (pulsed) | (100 μs pulse, 100 pps) | I_{FP} | | 1 | Α |
| | Input reverse voltage | | V_R | | 5 | V |
| | Input power dissipation | | P_D | | 50 | mW |
| | Input power dissipation derating | (T _a ≥ 25 °C) | $\Delta P_D/\Delta T_a$ | | -0.5 | mW/°C |
| | Junction temperature | | Tj | | 125 | °C |
| Detector | OFF-state output terminal voltage | | V _{OFF} | | 20 | V |
| | ON-state current (A connection) | | I _{ON} | (Note 1) | 4 | Α |
| | ON-state current (B connection) | | | | 4 | |
| | ON-state current (C connection) | | | | 8 |] |
| | ON-state current derating (A connection) | (T _a ≥ 25 °C) | Δl _{ON} /ΔT _a | (Note 1) | -40 | mA/°C |
| | ON-state current derating (B connection) | (T _a ≥ 25 °C) | | | -40 | |
| | ON-state current derating (C connection) | (T _a ≥ 25 °C) | | | -80 | |
| | ON-state current (pulsed) | (t = 100 ms, Duty = 1/10) | I _{ONP} | | 12 | Α |
| | Output power dissipation | | Po | | 500 | mW |
| | Output power dissipation derating | (T _a ≥ 25 °C) | $\Delta P_{O}/\Delta T_{a}$ | | -5.0 | mW/°C |
| | Junction temperature | | Tj | | 125 | °C |
| Common | Storage temperature | | T _{stg} | | -55 to 125 |] |
| | Operating temperature | | T _{opr} | | -40 to 85 |] |
| | Lead soldering temperature | (10 s) | T _{sol} | | 260 |] |
| | Isolation voltage | AC, 60 s, R.H. ≤ 60 % | BV _S | (Note 2) | 2500 | Vrms |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For an application circuit example, see Fig. 12.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.



7. Recommended Operating Conditions (Note)

| Characteristics | Symbol | Note | Min | Тур. | Max | Unit |
|---------------------------------|------------------|------|-----|------|-----|------|
| Supply voltage | V_{DD} | | _ | _ | 16 | V |
| Input forward current | I _F | | 5 | 10 | 25 | mA |
| ON-state current (A connection) | I _{ON} | | _ | | 4 | Α |
| Operating temperature | T _{opr} | | -20 | | 65 | °C |

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

8. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

| | Characteristics | Symbol | Note | Test Condition | Min | Тур. | Max | Unit |
|----------|-----------------------|------------------|------|-------------------------|------|------|------|------|
| LED | Input forward voltage | V _F | | I _F = 10 mA | 1.18 | 1.33 | 1.48 | V |
| | Input reverse current | I _R | | V _R = 5 V | | | 10 | μА |
| | Input capacitance | Ct | | V = 0 V, f = 1 MHz | _ | 70 | _ | pF |
| Detector | OFF-state current | I _{OFF} | | V _{OFF} = 20 V | _ | _ | 1 | μА |
| | Output capacitance | C _{OFF} | · | V = 0 V, f = 1 MHz | _ | 1000 | _ | pF |

9. Coupled Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

| Characteristics | Symbol | Note | Test Condition | Min | Тур. | Max | Unit |
|------------------------------------|-----------------|----------|---|-----|------|-----|------|
| Trigger LED current | I _{FT} | | I _{ON} = 1.0 A | - | 0.5 | 3 | mA |
| Return LED current | I _{FC} | | I _{OFF} = 10 μA | 0.1 | _ | _ | |
| ON-state resistance (A connection) | R _{ON} | (Note 1) | I _{ON} = 2.0 A, I _F = 5 mA, t < 1 s | _ | 20 | 50 | mΩ |
| ON-state resistance (B connection) | | | | _ | 10 | _ | |
| ON-state resistance (C connection) | | | I _{ON} = 4.0 A, I _F = 5 mA, t < 1 s | | 5 | _ | |

Note 1: For an application circuit example, see Fig. 12.2.

10. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

| Characteristics | Symbol | Note | Test Condition | Min | Тур. | Max | Unit |
|-------------------------------------|----------------|----------|-------------------------------------|----------------------|------|-----|------|
| Total capacitance (input to output) | Cs | (Note 1) | V _S = 0 V, f = 1 MHz | _ | 0.8 | _ | pF |
| Isolation resistance | R _S | (Note 1) | V _S = 500 V, R.H. ≤ 60 % | 5 × 10 ¹⁰ | 1014 | | Ω |
| Isolation voltage | BVS | (Note 1) | AC, 60 s | 2500 | _ | _ | Vrms |
| | | | AC, 1 s in oil | _ | 5000 | _ | |
| | | | DC, 60 s in oil | _ | 5000 | _ | Vdc |

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.



11. Switching Characteristics (Unless otherwise specified, Ta = 25 °C)

| Characteristics | Symbol | Note | Test Condition | Min | Тур. | Max | Unit |
|-----------------|------------------|------|--|-----|------|-----|------|
| Turn-on time | t _{ON} | | See Fig. 11.1. | _ | 2.5 | 5 | ms |
| Turn-off time | t _{OFF} | | $R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$ | _ | 0.1 | 1 | |
| Turn-on time | t _{ON} | · | See Fig. 11.1. | _ | 1 | 3 | |
| Turn-off time | t _{OFF} | | $R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 10 mA$ | | 0.1 | 1 | |

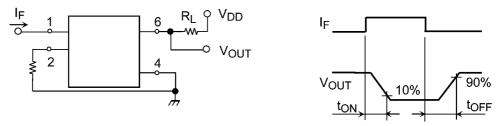


Fig. 11.1 Switching Time Test Circuit and Waveform



12. Characteristics Curves and Circuit Connections

12.1. Characteristics Curves (Note)

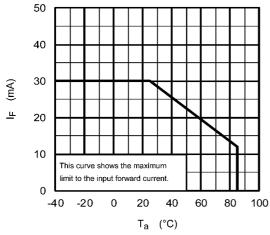


Fig. 12.1.1 I_F - T_a

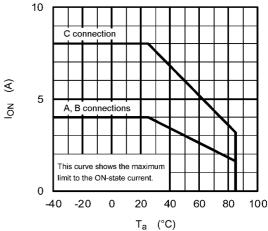


Fig. 12.1.2 I_{ON} - T_a

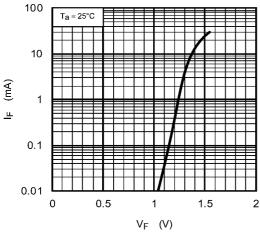


Fig. 12.1.3 I_F - V_F

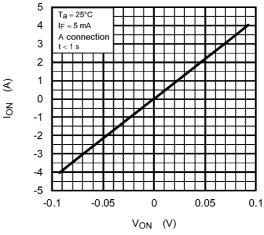


Fig. 12.1.4 I_{ON} - V_{ON}

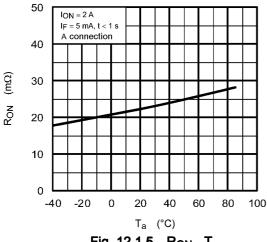


Fig. 12.1.5 R_{ON} - T_a

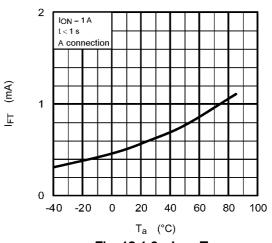


Fig. 12.1.6 I_{FT} - T_a



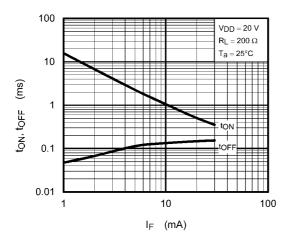


Fig. 12.1.7 t_{ON}, t_{OFF} - I_F

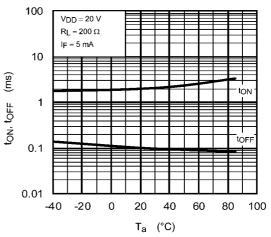


Fig. 12.1.8 t_{ON}, t_{OFF} - T_a

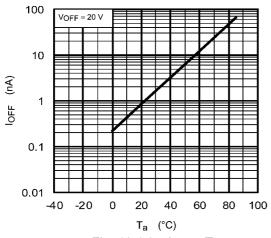


Fig. 12.1.9 I_{OFF} - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



12.2. Circuit Connections

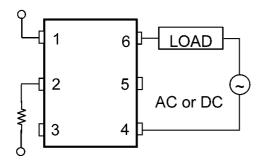


Fig. 12.2.1 A Connection

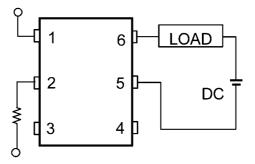


Fig. 12.2.2 B Connection

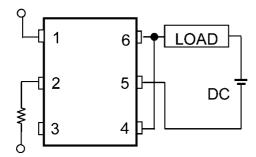
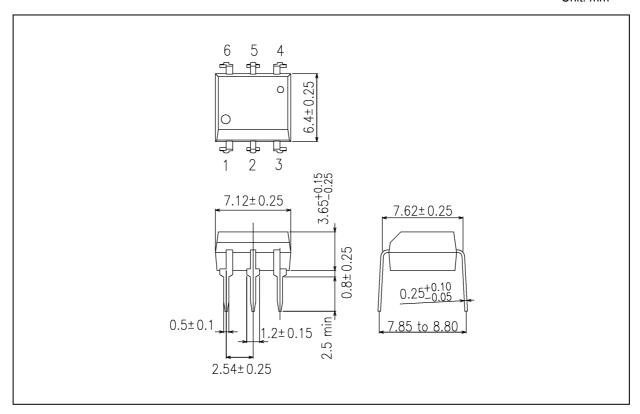


Fig. 12.2.3 C Connection



Package Dimensions

Unit: mm



Weight: 0.4 g (typ.)

| | Package Name(s) |
|------------------|-----------------|
| TOSHIBA: 11-7A8S | |

Rev.3.0



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